

# 9-Line SCSI Terminator –DS21S07A Upgrade

#### DESCRIPTION

The IMP5115 SCSI terminator is part of IMP's family of high-performance, adaptive, non-linear mode SCSI products, which are designed to deliver true UltraSCSI performance in SCSI applications. The low voltage BiCMOS architecture employed in its design offers performance superior to older linear passive and active techniques. IMP's SCSI termination architecture employs high-speed adaptive elements for each channel, thereby providing the fastest response possible — typically 35MHz, which is 100 times faster than the older linear regulator/ terminator approach used by other manufacturers. Products using this older linear regulator approach have bandwidths which are dominated by the output capacitor and which are limited to 500KHz (see further discussion in the Functional Description section). This new architecture also eliminates the output compensation capacitor required in earlier terminator designs. Each is approved for use with SCSI-1, -2, -3, UltraSCSI and beyond - providing the highest performance alternative available today.

Another key improvement offered by the IMP5115 lies in its ability to insure reliable, error-free communications even in systems which do not adhere to recommended SCSI hardware design guidelines, such as the use of improper

cable lengths and impedances. Frequently, this situation is not controlled by the peripheral or host designer and, when problems occur, they are the first to be made aware of the problem. The IMP5115 architecture is much more tolerant of marginal system integrations.

Recognizing the needs of portable and configurable peripherals, the IMP5115 has a TTL compatible sleep/disable mode. Quiescent current is typically less than 375µA in this mode, while the output capacitance is also less than 3pF. The obvious advantage of extended battery life for portable systems is inherent in the product's sleep-mode feature. Additionally, the disable function permits factory-floor or production-line configurability, reducing inventory and product-line diversity costs. Field configurability can also be accomplished without physically removing components which, often times results in field returns due to mishandling.

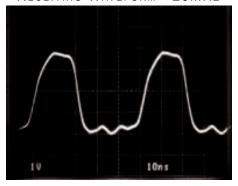
Reduced component count is also inherent in the IMP5115 architecture. Traditional termination techniques require large stabilization and transient protection capacitors of up to  $20\mu F$  in value and size. The IMP5115 architecture does not require these components, allowing all the cost savings associated with inventory, board space, assembly, reliability, and component costs.

#### **KEY FEATURES**

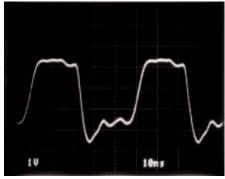
- ULTRA-FAST RESPONSE FOR FAST-20 SCSI APPLICATIONS
- 35MHz CHANNEL BANDWIDTH
- 3.5V OPERATION
- LESS THAN 3pf OUTPUT CAPACITANCE
- SLEEP-MODE CURRENT LESS THAN 375µA
- THERMALLY SELF LIMITING
- <u>NO</u> EXTERNAL COMPENSATION CAPACITORS
- IMPLEMENTS 8-BIT OR 16-BIT (WIDE) APPLICATIONS
- COMPATIBLE WITH ACTIVE NEGATION DRIVERS (60mA / CHANNEL)
- COMPATIBLE WITH PASSIVE AND ACTIVE TERMINATIONS
- APPROVED FOR USE WITH SCSI 1, 2, 3 AND ULTRA SCSI
- HOT SWAP COMPATIBLE
- PIN-FOR-PIN COMPATIBLE WITH DS21S07A / 2105

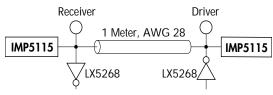
## **PRODUCT HIGHLIGHT**











## **PACKAGE ORDER INFORMATION**



Note: All surface-mount packages are available in Tape & Reel. Append the letter "T" to part number. (i.e. IMP5115CDWT)

# **ABSOLUTE MAXIMUM RATINGS (Note 1)**

Continuous Termination Voltage	10V
Continuous Output Voltage Range	
Continuous Disable Voltage Range	0 to 5.5V
Operating Junction Temperature	0°C to 125°C
Storage Temperature Range	65°C to +150°C
Solder Temperature (Soldering, 10 seconds)	

Note 1. Exceeding these ratings could cause damage to the device.

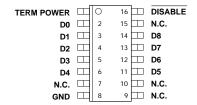
#### THERMAL DATA

## D PACKAGE:

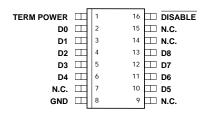
Junction Temperature Calculation:  $T_{I} = T_{A} + (P_{D} \times \theta_{IA})$ .

The  $\theta_{JA}$  numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

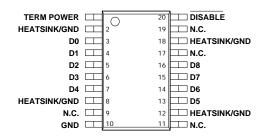
## **PACKAGE PIN OUTS**



**D PACKAGE** (Top View)



**DW PACKAGE** (Top View)



**PWP PACKAGE** (Top View)

# **RECOMMENDED OPERATING CONDITIONS (Note 2)**

Parameter	Symbol	Recommended Operating Conditions			Units
1 diameter		Min.	Тур.	Max.	Office
Termination Voltage	V <sub>TERM</sub>	3.5		5.5	٧
High Level Enable Input Voltage	V <sub>IH</sub>	2		V <sub>TERM</sub>	٧
Low Level Disable Input Voltage	V <sub>IL</sub>	0		0.8	٧
Operating Virtual Junction Temperature Range					
IMP5115C		0		125	°C

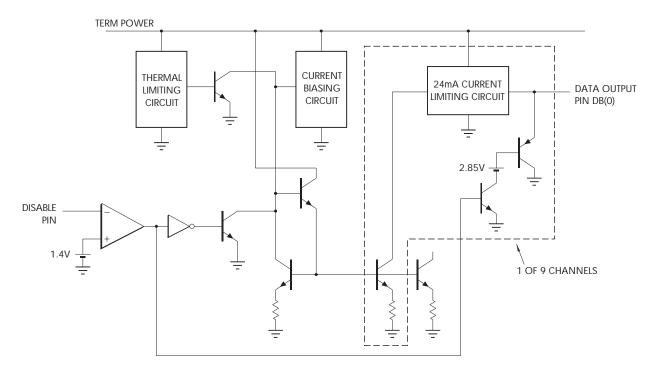
Note 2. Range over which the device is functional.

## **ELECTRICAL CHARACTERISTICS**

**Term Power = 4.75V unless otherwise specified.** Unless otherwise specified, these specifications apply at the recommended operating ambient temperature of  $T_A$  = 25°C. Low duty cycle pulse testing techniques are used which maintains junction and case temperatures equal to the ambient temperature.

Dawana daw	Symbol	Test Conditions	IMP5115			11
Parameter			Min.	Тур.	Max.	Units
Output High Voltage	V <sub>OUT</sub>		2.65	2.85		٧
TermPwr Supply Current	Icc	All data lines = open		6	9	mA
		All data lines = 0.5V		215	225	mA
		Disable Pin < 0.8V		375		μA
Output Current	Іоит	$V_{OUT} = 0.5V$	-21	-23	-24	mA
Disable Input Current	I <sub>IN</sub>	Disable Pin = 4.75V		10		nA
		Disable Pin = 0V		-90		μA
Output Leakage Current	I <sub>OL</sub>	Disable Pin = $< 0.8V, V_0 = 0.5V$		10		nA
Capacitance in Disabled Mode	C <sub>OUT</sub>	V <sub>OUT</sub> = 0V, frequency = 1MHz		3		рF
Channel Bandwidth	BW			35		MHz
Termination Sink Current, per Channel	I <sub>SINK</sub>	V <sub>OUT</sub> = 4V		60		mA

## **BLOCK DIAGRAM**



## **FUNCTIONAL DESCRIPTION**

Cable transmission theory suggests to optimize signal speed and quality, the termination should act both as an ideal voltage reference when the line is released (deasserted) and as an ideal current source when the line is active (asserted). Common active

terminators, which consist of Linear Regulators in series with resistors (typically  $110\Omega$ ), are a compromise. As the line voltage increases, the amount of current decreases linearly by the equation V = I \* R. The IMP5115, with its unique new architecture applies the maximum amount of current regardless of line voltage until the termination high threshold (2.85V) is reached.

Acting as a near ideal line terminator, the IMP5115 closely reproduces the optimum case when the device is enabled. To enable the device the Disable Pin must be pulled Logic High or left open. During this mode of operation, quiescent current is 6mA and the device will respond to line demands by delivering

24mA on assertion and by imposing 2.85V on deassertion. In order to disable the device, the Disable pin must be driven logic **Low**. This mode of operation places the device in a sleep state where a meager 375µA of quiescent current is consumed.

Additionally, all outputs are in a Hi-Z (impedance) state. Sleep mode can be used for power conservation or to completely eliminate the terminator from the SCSI chain. In the second case, termination node capacitance is important to consider. The terminator will appear as a parasitic distributed capacitance on the line, which can detract from bus performance. For this reason, the IMP5115 has been opti-

mized to have only 3pF of capacitance per output in the sleep

An additional feature of the IMP5115 is its compatibility with active negation drivers. The device handles up to 60 mA of sink current for drivers which exceed the 2.85V output high.

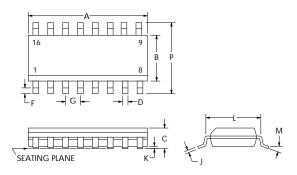
POWER UP / POWER DOWN FUNCTION TABLE

Disable IMP5115	Outputs	Quiescent Current
Н	Enabled	6mA
L	HI Z	375μΑ
Open	Enabled	6mA

## **PACKAGE DIMENSIONS**

D

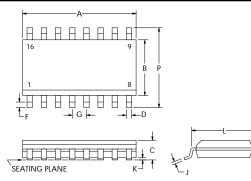
16-Pin Plastic S.O.I.C.



	MILLIM	INCHES		
DIM	MIN	MAX		
Α	9.78	10.01	0.385	0.394
В	3.81	4.01	0.150	0.158
С	1.35	1.75	0.053	0.069
D	0.35	0.46	0.014	0.018
F	0.51	0.77	0.020	0.030
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.007	0.010
K	0.10	0.25	0.004	0.010
L	4.82	5.21	0.189	0.205
M	0°	8°	0°	8°
P	5.79	6.20	0.228	0.244



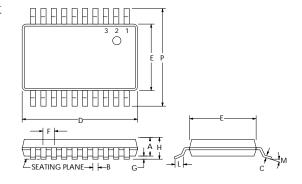
16-Pin Plastic (SOWB) Widebody S.O.I.C.



MILLIMETERS			INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	_	10.67	_	0.420	
В	7.49	7.75	0.295	0.305	
С	2.35	2.65	0.093	0.104	
D	0.25	0.46	0.010	0.018	
F	0.64	0.89	0.025	0.035	
G	1.27 BSC		0.050 BSC		
J	0.23	0.32	0.009	0.013	
K	0.10	0.30	0.004	0.012	
L	8.13	8.64	0.320	0.340	
М	0°	8°	0°	8°	
Р	10.26	10.65	0.404	0.419	



20-Pin Thin Small Shrink Outline (TSSOP)



MILLIMETERS			INCHES		
MIC	MIN	MAX	MIN	MAX	
Α	_	0.90	_	0.354	
В	0.18	0.30	0.0071	0.0118	
С	0.90	0.180	0.0035	0.0071	
D	6.40	6.60	0.252	0.260	
E	4.30	4.48	0.169	0.176	
F	0.65	BSC	0.02	5 BSC	
G	0.05	0.15	0.002	0.005	
Н	_	1.10	_	0.0433	
L	0.50	0.70	0.020	0.028	
M	0°	8°	0°	8°	
P	6.25	6.50	0.246	0.256	



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